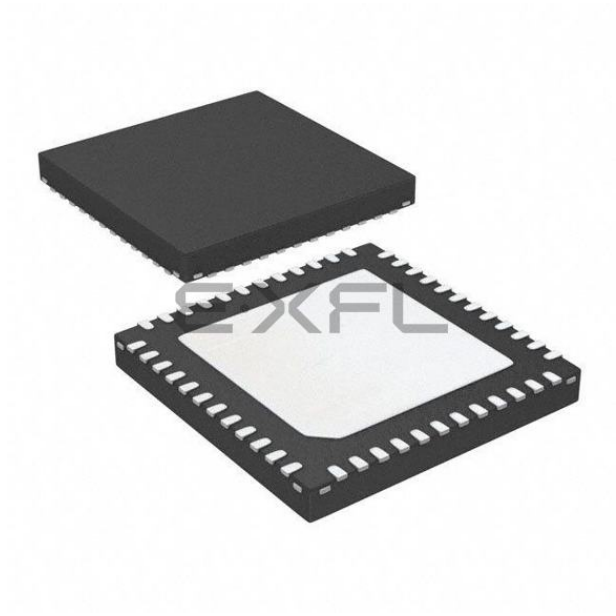

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"Embedded - Microcontrollers" refer to small, integrated circuits designed to perform specific tasks within larger systems. These microcontrollers are essentially compact computers on a single chip, containing a processor core, memory, and programmable input/output peripherals. They are called "embedded" because they are embedded within electronic devices to control various functions, rather than serving as standalone computers. Microcontrollers are crucial in modern electronics, providing the intelligence and control needed for a wide range of applications.

Applications of "Embedded - Microcontrollers"

Details	
Product Status	Not For New Designs
Core Processor	RX
Core Size	32-Bit Single-Core
Speed	32MHz
Connectivity	I²C, SCI, SPI, USB
Peripherals	DMA, LVD, POR, PWM, WDT
Number of I/O	30
Program Memory Size	96KB (96K x 8)
Program Memory Type	FLASH
EEPROM Size	8K x 8
RAM Size	16K x 8
Voltage - Supply (Vcc/Vdd)	1.8V ~ 3.6V
Data Converters	A/D 10x12b
Oscillator Type	Internal
Operating Temperature	-40°C ~ 85°C (TA)
Mounting Type	Surface Mount
Package / Case	48-WFQFN Exposed Pad
Supplier Device Package	48-HWQFN (7x7)
Purchase URL	https://www.e-xfl.com/product-detail/renesas-electronics-america/r5f51114adne-ua

Table 1.1 Outline of Specifications (3/3)

Classification	Module/Function	Description
Communication function	USB 2.0 host/function module (USBc)	• USB Device Controller (UDC) and transceiver for USB 2.0 are incorporated. • Host (32-Kbyte or more ROM)/function module: 1 port • Compliant with USB version 2.0 • Transfer speed: Full-speed (12 Mbps), low-speed (1.5 Mbps) • OTG (On-The-Go) is supported. • Isochronous transfer is supported. • BC (Battery Charger) is supported.
12-bit A/D converter (S12ADb)		• 1 unit (1 unit × 14 channels) • 12-bit resolution • Minimum conversion time: 1.0 µs per channel when the ADCLK is operating at 32 MHz • Operating modes Scan mode (single scan mode, continuous scan mode, and group scan mode) • Double trigger mode (duplication of A/D conversion data) • A/D conversion start conditions A software trigger, a trigger from a timer (MTU), an external trigger signal, or ELC
Temperature sensor (TEMPSA)		• 1 channel • The voltage of the temperature is converted into a digital value by the 12-bit A/D converter.
D/A converter (DA)		• 2 channels • 8-bit resolution • Output voltage: 0 V to VCC
CRC calculator (CRC)		• CRC code generation for arbitrary amounts of data in 8-bit units • Select any of three generating polynomials: $X^8 + X^2 + X + 1$, $X^{16} + X^{15} + X^2 + 1$, or $X^{16} + X^{12} + X^5 + 1$ • Generation of CRC codes for use with LSB first or MSB first communications is selectable.
Data operation circuit (DOC)		Comparison, addition, and subtraction of 16-bit data
Unique ID		32-byte ID code for the MCU
Power supply voltages/Operating frequencies		VCC = 1.8 to 2.4 V: 8 MHz, VCC = 2.4 to 2.7 V: 16 MHz, VCC = 2.7 to 3.6 V: 32 MHz
Supply current		3.2 mA at 32 MHz (typ.)
Operating temperature range		D version: –40 to +85°C, G version: –40 to +105°C
Packages		64-pin LFQFP (PLQP0064KB-A) 10 × 10 mm, 0.5 mm pitch 64-pin LQFP (PLQP0064GA-A) 14 × 14 mm, 0.8 mm pitch 64-pin WFLGA (PWLG0064KA-A) 5 × 5 mm, 0.5 mm pitch 48-pin LFQFP (PLQP0048KB-A) 7 × 7 mm, 0.5 mm pitch 48-pin HWQFN (PWQN0048KB-A) 7 × 7 mm, 0.5 mm pitch 40-pin HWQFN (PWQN0040KC-A) 6 × 6 mm, 0.50 mm pitch 36-pin WFLGA (PWLG0036KA-A) 4 × 4 mm, 0.5 mm pitch
On-chip debugging system		E1 emulator (FINE interface)

1.2 List of Products

Table 1.3 is a list of products, and Figure 1.1 shows how to read the product part no., memory capacity, and package type.

Table 1.3 List of Products (1/2)

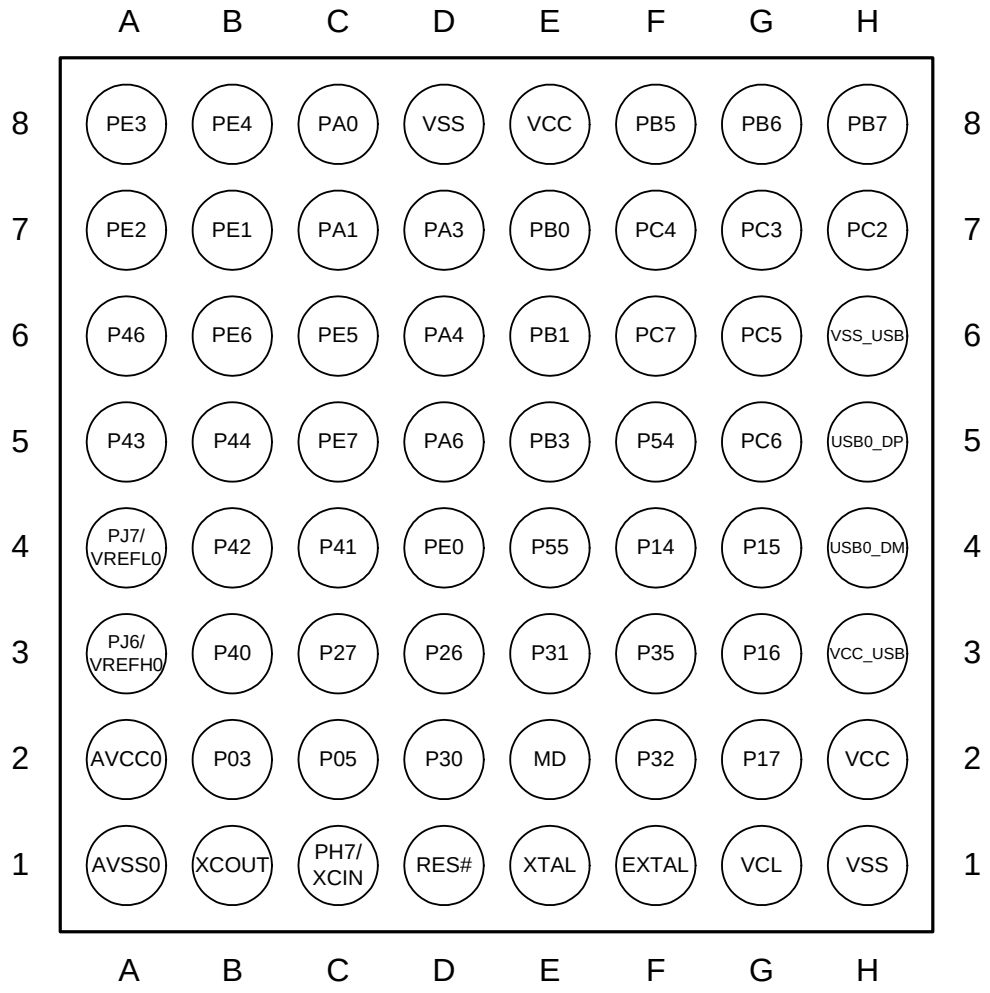
Group	Part No.	Orderable Part No.	Package	ROM Capacity	RAM Capacity	E2 DataFlash	Maximum Operating Frequency	Operating Temperature
RX111	R5F51118AGFM	R5F51118AGFM#3A	PLQP0064KB-A	512 Kbytes	64 Kbytes	8 Kbytes	32 MHz	–40 to +105°C
	R5F51118AGFK	R5F51118AGFK#3A	PLQP0064GA-A					
	R5F51118AGFL	R5F51118AGFL#3A	PLQP0048KB-A					
	R5F51118AGNE	R5F51118AGNE#UA	PWQN0048KB-A					
	R5F51117AGFM	R5F51117AGFM#3A	PLQP0064KB-A	384 Kbytes				
	R5F51117AGFK	R5F51117AGFK#3A	PLQP0064GA-A					
	R5F51117AGFL	R5F51117AGFL#3A	PLQP0048KB-A					
	R5F51117AGNE	R5F51117AGNE#UA	PWQN0048KB-A					
	R5F51116AGFM	R5F51116AGFM#3A	PLQP0064KB-A	256 Kbytes	32 Kbytes			
	R5F51116AGFK	R5F51116AGFK#3A	PLQP0064GA-A					
	R5F51116AGFL	R5F51116AGFL#3A	PLQP0048KB-A					
	R5F51116AGNE	R5F51116AGNE#UA	PWQN0048KB-A					
	R5F51115AGFM	R5F51115AGFM#3A	PLQP0064KB-A	128 Kbytes	16 Kbytes			
	R5F51115AGFK	R5F51115AGFK#3A	PLQP0064GA-A					
	R5F51115AGFL	R5F51115AGFL#3A	PLQP0048KB-A					
	R5F51115AGNE	R5F51115AGNE#UA	PWQN0048KB-A					
	R5F51114AGFM	R5F51114AGFM#3A	PLQP0064KB-A	96 Kbytes				
	R5F51114AGFK	R5F51114AGFK#3A	PLQP0064GA-A					
	R5F51114AGFL	R5F51114AGFL#3A	PLQP0048KB-A					
	R5F51114AGNE	R5F51114AGNE#UA	PWQN0048KB-A					
	R5F51113AGFM	R5F51113AGFM#3A	PLQP0064KB-A	64 Kbytes	10 Kbytes			
	R5F51113AGFK	R5F51113AGFK#3A	PLQP0064GA-A					
	R5F51113AGFL	R5F51113AGFL#3A	PLQP0048KB-A					
	R5F51113AGNE	R5F51113AGNE#UA	PWQN0048KB-A					
	R5F51113AGNF	R5F51113AGNF#UA	PWQN0040KC-A					
	R5F51111AGFM	R5F51111AGFM#3A	PLQP0064KB-A	32 Kbytes				
	R5F51111AGFK	R5F51111AGFK#3A	PLQP0064GA-A					
	R5F51111AGFL	R5F51111AGFL#3A	PLQP0048KB-A					
	R5F51111AGNE	R5F51111AGNE#UA	PWQN0048KB-A					
	R5F51111AGNF	R5F51111AGNF#UA	PWQN0040KC-A					
	R5F5111JAGFM	R5F5111JAGFM#3A	PLQP0064KB-A	16 Kbytes	8 Kbytes			
	R5F5111JAGFK	R5F5111JAGFK#3A	PLQP0064GA-A					
	R5F5111JAGFL	R5F5111JAGFL#3A	PLQP0048KB-A					
	R5F5111JAGNE	R5F5111JAGNE#UA	PWQN0048KB-A					
	R5F5111JAGNF	R5F5111JAGNF#UA	PWQN0040KC-A					

Table 1.3 List of Products (2/2)

Group	Part No.	Orderable Part No.	Package	ROM Capacity	RAM Capacity	E2 DataFlash	Maximum Operating Frequency	Operating Temperature
RX111	R5F51118ADFM	R5F51118ADFM#3A	PLQP0064KB-A	512 Kbytes	64 Kbytes	8 Kbytes	32 MHz	–40 to +85°C
	R5F51118ADFK	R5F51118ADFK#3A	PLQP0064GA-A					
	R5F51118ADLF	R5F51118ADLF#UA	PWLG0064KA-A					
	R5F51118ADFL	R5F51118ADFL#3A	PLQP0048KB-A					
	R5F51118ADNE	R5F51118ADNE#UA	PWQN0048KB-A					
	R5F51117ADFM	R5F51117ADFM#3A	PLQP0064KB-A	384 Kbytes				
	R5F51117ADFK	R5F51117ADFK#3A	PLQP0064GA-A					
	R5F51117ADLF	R5F51117ADLF#UA	PWLG0064KA-A					
	R5F51117ADFL	R5F51117ADFL#3A	PLQP0048KB-A					
	R5F51117ADNE	R5F51117ADNE#UA	PWQN0048KB-A					
	R5F51116ADFM	R5F51116ADFM#3A	PLQP0064KB-A	256 Kbytes	32 Kbytes			
	R5F51116ADFK	R5F51116ADFK#3A	PLQP0064GA-A					
	R5F51116ADLF	R5F51116ADLF#UA	PWLG0064KA-A					
	R5F51116ADFL	R5F51116ADFL#3A	PLQP0048KB-A					
	R5F51116ADNE	R5F51116ADNE#UA	PWQN0048KB-A					
	R5F51115ADFM	R5F51115ADFM#3A	PLQP0064KB-A	128 Kbytes	16 Kbytes			
	R5F51115ADFK	R5F51115ADFK#3A	PLQP0064GA-A					
	R5F51115ADLF	R5F51115ADLF#UA	PWLG0064KA-A					
	R5F51115ADFL	R5F51115ADFL#3A	PLQP0048KB-A					
	R5F51115ADNE	R5F51115ADNE#UA	PWQN0048KA-A					
	R5F51114ADFM	R5F51114ADFM#3A	PLQP0064KB-A	96 Kbytes				
	R5F51114ADFK	R5F51114ADFK#3A	PLQP0064GA-A					
	R5F51114ADLF	R5F51114ADLF#UA	PWLG0064KA-A					
	R5F51114ADFL	R5F51114ADFL#3A	PLQP0048KB-A					
	R5F51114ADNE	R5F51114ADNE#UA	PWQN0048KB-A					
	R5F51113ADFM	R5F51113ADFM#3A	PLQP0064KB-A	64 Kbytes	10 Kbytes			
	R5F51113ADFK	R5F51113ADFK#3A	PLQP0064GA-A					
	R5F51113ADLF	R5F51113ADLF#UA	PWLG0064KA-A					
	R5F51113ADFL	R5F51113ADFL#3A	PLQP0048KB-A					
	R5F51113ADNE	R5F51113ADNE#UA	PWQN0048KB-A					
	R5F51113ADLM	R5F51113ADLM#UA	PWLG0036KA-A					
	R5F51113ADNF	R5F51113ADNF#UA	PWQN0040KC-A					
	R5F51111ADFM	R5F51111ADFM#3A	PLQP0064KB-A	32 Kbytes				
	R5F51111ADFK	R5F51111ADFK#3A	PLQP0064GA-A					
	R5F51111ADLF	R5F51111ADLF#UA	PWLG0064KA-A					
	R5F51111ADFL	R5F51111ADFL#3A	PLQP0048KB-A					
	R5F51111ADNE	R5F51111ADNE#UA	PWQN0048KB-A					
	R5F51111ADLM	R5F51111ADLM#UA	PWLG0036KA-A					
	R5F51111ADNF	R5F51111ADNF#UA	PWQN0040KC-A					
	R5F5111JADFM	R5F5111JADFM#3A	PLQP0064KB-A	16 Kbytes	8 Kbytes			
	R5F5111JADFK	R5F5111JADFK#3A	PLQP0064GA-A					
	R5F5111JADLF	R5F5111JADLF#UA	PWLG0064KA-A					
	R5F5111JADFL	R5F5111JADFL#3A	PLQP0048KB-A					
	R5F5111JADNE	R5F5111JADNE#UA	PWQN0048KB-A					
	R5F5111JADLM	R5F5111JADLM#UA	PWLG0036KA-A					
	R5F5111JADNF	R5F5111JADNF#UA	PWQN0040KC-A					

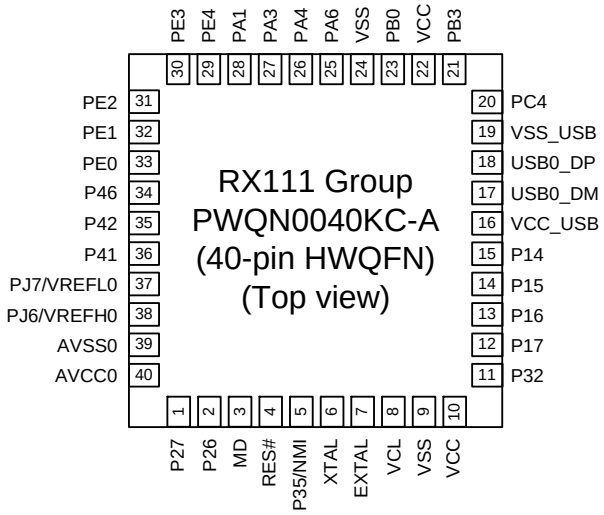
Note: • Orderable part numbers are current as of when this manual was published. Please make sure to refer to the relevant product page on the Renesas website for the latest part numbers.

RX111 Group
PWLG0064KA-A
(64-pin WFLGA)
(Upper perspective view)



Note: • This figure indicates the power supply pins and I/O port pins. For the pin configuration, see the table “List of Pins and Pin Functions (64-Pin WFLGA)”.
• For the position of A1 pin in the package, see “Package Dimensions”.

Figure 1.4 Pin Assignments of the 64-Pin WFLGA



Note: • This figure indicates the power supply pins and I/O port pins.
For the pin configuration, see the table “List of Pins and Pin Functions (40-Pin HWQFN)”.
Note: • It is recommended that the exposed die pad of HWQFN should be connected to VSS.

Figure 1.6 Pin Assignments of the 40-Pin HWQFN

Table 1.8 List of Pins and Pin Functions (40-Pin HWQFN) (2/2)

Pin No.	Power Supply, Clock, System Control	I/O Port	Timers (MTU, POE, RTC)	Communication (SCIe, SCIf, RSPI, RIIC, USB)	Others
40	AVCC0				

Note 1. Not 5 V tolerant.
Note 2. The power source of the I/O buffer for these pins is AVCC0.

Table 1.9 List of Pins and Pin Functions (36-Pin WFLGA)

Pin No.	Power Supply, Clock, System Control	I/O Port	Timers (MTU, POE, RTC)	Communication (SCIe, SCIf, RSPI, RIIC, USB)	Others
A1	AVSS0				
A2	AVCC0				
A3	VREFH0	PJ6*2			
A4		P42*2			AN002
A5		P41*2			AN001
A6		PE2	MTIOC4A	RXD12/RXDX12/SMISO12/SSCL12	IRQ7/AN010
B1	RES#				
B2		P27	MTIOC2B	SCK1/SCK12	IRQ3/CMPA2/CACREF/ ADTRG0#
B3	VREFL0	PJ7*2			
B4		PE0	MTIOC2A/POE3#	SCK12	IRQ0/AN008
B5		PE1	MTIOC4C	TXD12/TXDX12/SIOX12/SMOSI12/ SSDA12	IRQ1/AN009
B6		PA3	MTIOC0D/MTCLKD/ MTIOC1B/POE0#	RXD5/SMISO5/SSCL5/MISOA	IRQ6
C1	XTAL				
C2	MD				FINED
C3		PE3	MTIOC0A/MTIOC1B/ MTIOC4B/POE8#	CTS12#/RTS12#/SS12#/RSPCKA	IRQ3/AN011
C4		PE4	MTIOC1A/MTIOC3A/ MTIOC4D	MOSIA	IRQ4/AN012
C5		PA4	MTIOC2B/MTIC5U/MTCLKA	TXD5/SMOSI5/SSDA5/SSLA0	IRQ5
C6	VSS				
D1	EXTAL				
D2	UPSEL	P35			NMI
D3	UB#	P14	MTIOC0A/MTIOC3A/ MTCLKA	CTS1#/RTS1#/SS1#/SSLA0/TXD12/ TXDX12/SIOX12/SMOSI12/ SSDA12/USB0_OVRCURA	IRQ4
D4		PA6	MTIC5V/MTCLKB/MTIOC2A/ POE2#	CTS5#/RTS5#/SS5#/SDA0/MOSIA	IRQ3
D5		PB3	MTIOC0A/MTIOC3B/ MTIOC4A/POE3#	USB0_OVRCURA	
D6		PB0	MTIOC0C/MTIC5W	SCL0/RSPCKA	IRQ2/ADTRG0#
E1	VCL				
E2		P17	MTIOC0C/MTIOC3A/ MTIOC3B/POE8#	SCK1/MISOA/SDA0/RXD12/ RXDX12/SMISO12/SSCL12	IRQ7
E3		P16	MTIOC3C/MTIOC3D	TXD1/SMOSI1/SSDA1/SCL0/ MOSIA/USB0_VBUSEN/ USB0_OVRCURB/USB0_VBUS	IRQ6/ADTRG0#
E4		P15	MTIOC0B/MTCLKB	RXD1/SMISO1/SSCL1/RSPCKA	IRQ5/CLKOUT
E5		PC4	MTIOC3D/MTCLKC/POE0#	SCK5/SSLA0/USB0_VBUSEN/ USB0_VBUS*1	IRQ2/CLKOUT
E6	VCC				
F1	VSS				
F2	VCC				
F3	VCC_USB				
F4				USB0_DM	
F5				USB0_DP	
F6	VSS_USB				

Note 1. Not 5 V tolerant.
Note 2. The power source of the I/O buffer for these pins is AVCC0.

- Longword-size I/O registers

```
MOV.L  #SFR_ADDR, R1
MOV.L  #SFR_DATA, [R1]
CMP    [R1].L, R1
;; Next process
```

When executing an instruction after writing to multiple registers, only read the last I/O register written to and execute the instruction using that value; it is not necessary to execute the instruction using the values written to all the registers.

(3) Number of cycles necessary for accessing I/O registers

See Table 4.1 for details on the number of clock cycles necessary for accessing I/O registers.
The number of access cycles to I/O registers is obtained by following equation.*1

Number of access cycles to I/O registers = Number of bus cycles for internal main bus 1 +
Number of divided clock synchronization cycles +
Number of bus cycles for internal peripheral buses 1 to 6

The number of bus cycles of internal peripheral buses 1 to 6 differs according to the register to be accessed.
When peripheral functions connected to internal peripheral buses 2 to 6 or registers for the external bus control unit (except for bus error related registers) are accessed, the number of divided clock synchronization cycles is added.
The number of divided clock synchronization cycles differs depending on the frequency ratio between ICLK and PCLK (or FCLK) or bus access timing.
In the peripheral function unit, when the frequency ratio of ICLK is equal to or greater than that of PCLK (or FCLK), the sum of the number of bus cycles for internal main bus 1 and the number of the divided clock synchronization cycles will be one cycle of PCLK (or FCLK) at a maximum. Therefore, one PCLK (or FCLK) has been added to the number of access cycles shown in Table 4.1.
When the frequency ratio of ICLK is lower than that of PCLK (or FCLK), the subsequent bus access is started from the ICLK cycle following the completion of the access to the peripheral functions. Therefore, the access cycles are described on an ICLK basis.

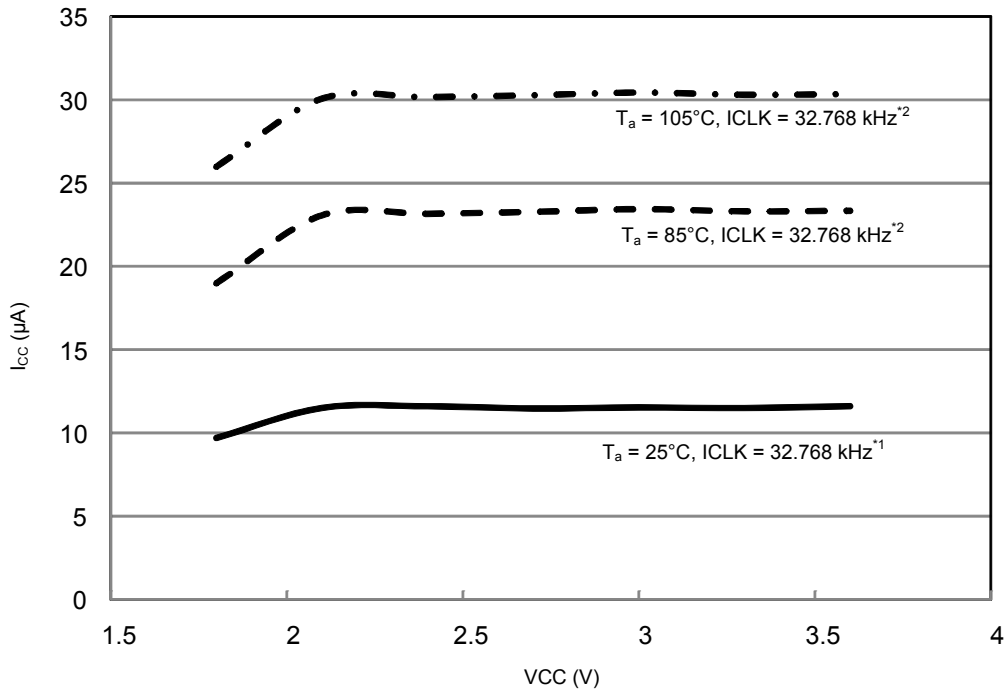
Note 1. This applies to the number of cycles when the access from the CPU does not conflict with the bus access from the different bus master (DTC).

(4) Notes on sleep mode and mode transitions

During sleep mode or mode transitions, do not write to the system control related registers (indicated by ‘SYSTEM’ in the Module Symbol column in Table 4.1, List of I/O Registers (Address Order)).

Table 4.1 List of I/O Registers (Address Order) (7/16)

Address	Module Symbol	Register Name	Register Symbol	Number of Bits	Access Size	Number of Access States
0008 838Dh	RSPI0	RSPI Slave Select Negation Delay Register	SSLND	8	8	2 or 3 PCLKB
0008 838Eh	RSPI0	RSPI Next-Access Delay Register	SPND	8	8	2 or 3 PCLKB
0008 838Fh	RSPI0	RSPI Control Register 2	SPCR2	8	8	2 or 3 PCLKB
0008 8390h	RSPI0	RSPI Command Register 0	SPCMD0	16	16	2 or 3 PCLKB
0008 8392h	RSPI0	RSPI Command Register 1	SPCMD1	16	16	2 or 3 PCLKB
0008 8394h	RSPI0	RSPI Command Register 2	SPCMD2	16	16	2 or 3 PCLKB
0008 8396h	RSPI0	RSPI Command Register 3	SPCMD3	16	16	2 or 3 PCLKB
0008 8398h	RSPI0	RSPI Command Register 4	SPCMD4	16	16	2 or 3 PCLKB
0008 839Ah	RSPI0	RSPI Command Register 5	SPCMD5	16	16	2 or 3 PCLKB
0008 839Ch	RSPI0	RSPI Command Register 6	SPCMD6	16	16	2 or 3 PCLKB
0008 839Eh	RSPI0	RSPI Command Register 7	SPCMD7	16	16	2 or 3 PCLKB
0008 8600h	MTU3	Timer Control Register	TCR	8	8	2 or 3 PCLKB
0008 8601h	MTU4	Timer Control Register	TCR	8	8	2 or 3 PCLKB
0008 8602h	MTU3	Timer Mode Register	TMDR	8	8	2 or 3 PCLKB
0008 8603h	MTU4	Timer Mode Register	TMDR	8	8	2 or 3 PCLKB
0008 8604h	MTU3	Timer I/O Control Register H	TIORH	8	8	2 or 3 PCLKB
0008 8605h	MTU3	Timer I/O Control Register L	TIORL	8	8	2 or 3 PCLKB
0008 8606h	MTU4	Timer I/O Control Register H	TIORH	8	8	2 or 3 PCLKB
0008 8607h	MTU4	Timer I/O Control Register L	TIORL	8	8	2 or 3 PCLKB
0008 8608h	MTU3	Timer Interrupt Enable Register	TIER	8	8	2 or 3 PCLKB
0008 8609h	MTU4	Timer Interrupt Enable Register	TIER	8	8	2 or 3 PCLKB
0008 860Ah	MTU	Timer Output Master Enable Register	TOER	8	8	2 or 3 PCLKB
0008 860Dh	MTU	Timer Gate Control Register	TGCR	8	8	2 or 3 PCLKB
0008 860Eh	MTU	Timer Output Control Register 1	TOCR1	8	8	2 or 3 PCLKB
0008 860Fh	MTU	Timer Output Control Register 2	TOCR2	8	8	2 or 3 PCLKB
0008 8610h	MTU3	Timer Counter	TCNT	16	16	2 or 3 PCLKB
0008 8612h	MTU4	Timer Counter	TCNT	16	16	2 or 3 PCLKB
0008 8614h	MTU	Timer Cycle Data Register	TCDR	16	16	2 or 3 PCLKB
0008 8616h	MTU	Timer Dead Time Data Register	TDDR	16	16	2 or 3 PCLKB
0008 8618h	MTU3	Timer General Register A	TGRA	16	16	2 or 3 PCLKB
0008 861Ah	MTU3	Timer General Register B	TGRB	16	16	2 or 3 PCLKB
0008 861Ch	MTU4	Timer General Register A	TGRA	16	16	2 or 3 PCLKB
0008 861Eh	MTU4	Timer General Register B	TGRB	16	16	2 or 3 PCLKB
0008 8620h	MTU	Timer Subcounter	TCNTS	16	16	2 or 3 PCLKB
0008 8622h	MTU	Timer Cycle Buffer Register	TCBR	16	16	2 or 3 PCLKB
0008 8624h	MTU3	Timer General Register C	TGRC	16	16	2 or 3 PCLKB
0008 8626h	MTU3	Timer General Register D	TGRD	16	16	2 or 3 PCLKB
0008 8628h	MTU4	Timer General Register C	TGRC	16	16	2 or 3 PCLKB
0008 862Ah	MTU4	Timer General Register D	TGRD	16	16	2 or 3 PCLKB
0008 862Ch	MTU3	Timer Status Register	TSR	8	8	2 or 3 PCLKB
0008 862Dh	MTU4	Timer Status Register	TSR	8	8	2 or 3 PCLKB
0008 8630h	MTU	Timer Interrupt Skipping Set Register	TITCR	8	8	2 or 3 PCLKB
0008 8631h	MTU	Timer Interrupt Skipping Counter	TITCNT	8	8	2 or 3 PCLKB
0008 8632h	MTU	Timer Buffer Transfer Set Register	TBTER	8	8	2 or 3 PCLKB
0008 8634h	MTU	Timer Dead Time Enable Register	TDER	8	8	2 or 3 PCLKB
0008 8636h	MTU	Timer Output Level Buffer Register	TOLBR	8	8	2 or 3 PCLKB
0008 8638h	MTU3	Timer Buffer Operation Transfer Mode Register	TBTM	8	8	2 or 3 PCLKB
0008 8639h	MTU4	Timer Buffer Operation Transfer Mode Register	TBTM	8	8	2 or 3 PCLKB
0008 8640h	MTU4	Timer A/D Converter Start Request Control Register	TADCR	16	16	2 or 3 PCLKB
0008 8644h	MTU4	Timer A/D Converter Start Request Cycle Set Register A	TADCORA	16	16	2 or 3 PCLKB
0008 8646h	MTU4	Timer A/D Converter Start Request Cycle Set Register B	TADCORB	16	16	2 or 3 PCLKB
0008 8648h	MTU4	Timer A/D Converter Start Request Cycle Set Buffer Register A	TADCOBRA	16	16	2 or 3 PCLKB



Note 1. All peripheral operation is normal.
Average value of the tested middle samples during product evaluation.
Note 2. All peripheral operation is maximum.
Average value of the tested upper-limit samples during product evaluation.

Figure 5.3 Voltage Dependency in Low-Speed Operating Mode (Reference Data)

[256-Kbyte or more flash memory]

Table 5.8 DC Characteristics (6) (1/2)

Conditions: 1.8 V ≤ VCC = VCC_USB ≤ 3.6 V, 1.8 V ≤ AVSS0 ≤ 3.6 V, VSS = AVSS0 = VSS_USB = 0 V, T_a = –40 to +105°C

Item					Symbol	Typ *4	Max	Unit	Test Conditions
Supply current*1	High-speed operating mode	Normal operating mode	No peripheral operation*2	ICLK = 32 MHz	I_{CC}	3.6	—	mA	
				ICLK = 16 MHz		2.4	—		
				ICLK = 8 MHz		1.8	—		
			All peripheral operation: Normal*3	ICLK = 32 MHz		13.4	—		
				ICLK = 16 MHz		7.5	—		
				ICLK = 8 MHz		4.5	—		
			All peripheral operation: Max.*3	ICLK = 32 MHz		—	27		
		Sleep mode	No peripheral operation*2	ICLK = 32 MHz		1.9	—		
				ICLK = 16 MHz		1.5	—		
				ICLK = 8 MHz		1.3	—		
			All peripheral operation: Normal*3	ICLK = 32 MHz		7.6	—		
				ICLK = 16 MHz		4.4	—		
				ICLK = 8 MHz		2.8	—		
		Deep sleep mode	No peripheral operation*2	ICLK = 32 MHz		1.1	—		
				ICLK = 16 MHz		1.0	—		
				ICLK = 8 MHz		0.9	—		
			All peripheral operation: Normal*3	ICLK = 32 MHz		5.8	—		
				ICLK = 16 MHz		3.4	—		
				ICLK = 8 MHz		2.1	—		
		Increase during flash rewrite*5				2.5	—		
	Middle-speed operating modes	Normal operating mode	No peripheral operation*6	ICLK = 12 MHz	I_{CC}	2.1	—	mA	
				ICLK = 8 MHz		1.4	—		
				ICLK = 1 MHz		0.8	—		
			All peripheral operation: Normal*7	ICLK = 12 MHz		5.9	—		
				ICLK = 8 MHz		4.2	—		
				ICLK = 1 MHz		1.3	—		
			All peripheral operation: Max.*7	ICLK = 12 MHz		—	12.2		
		Sleep mode	No peripheral operation*6	ICLK = 12 MHz		1.4	—		
				ICLK = 8 MHz		0.9	—		
				ICLK = 1 MHz		0.7	—		
			All peripheral operation: Normal*7	ICLK = 12 MHz		3.6	—		
				ICLK = 8 MHz		2.5	—		
				ICLK = 1 MHz		1.1	—		
		Deep sleep mode	No peripheral operation*6	ICLK = 12 MHz		1.1	—		
				ICLK = 8 MHz		0.6	—		
				ICLK = 1 MHz		0.6	—		
			All peripheral operation: Normal*7	ICLK = 12 MHz		2.9	—		
				ICLK = 8 MHz		2.0	—		
				ICLK = 1 MHz		0.9	—		
		Increase during flash rewrite*5				2.5	—		

Table 5.17 Permissible Output Currents (1)

Conditions: 1.8 V ≤ VCC = VCC_USB ≤ 3.6 V, 1.8 V ≤ AVCC0 ≤ 3.6 V, VSS = AVSS0 = VSS_USB = 0 V,
T_a = –40 to +85°C (D version)

Item		Symbol	Max.	Unit
Permissible output low current (average value per pin)	Ports P40 to P44, P46, ports PJ6, PJ7	I_{OL}	0.4	mA
	Ports other than above		8.0	
Permissible output low current (maximum value per pin)	Ports P40 to P44, P46, ports PJ6, PJ7		0.4	
	Ports other than above		8.0	
Permissible output low current	Total of ports P40 to P44, P46, ports PJ6, PJ7	ΣI_{OL}	2.4	
	Total of ports P03, P05, ports P26, P27, ports P30, P31		30	
	Total of ports P14 to P17, port P32, ports P54, P55, ports PB0, PB1, PB3, PB5 to PB7, ports PC2 to PC7		30	
	Total of ports PA0, PA1, PA3, PA4, PA6, ports PE0 to PE7		30	
	Total of all output pins		60	
Permissible output high current (average value per pin)	Ports P40 to P44, P46, ports PJ6, PJ7	I_{OH}	–0.1	
	Ports other than above		–4.0	
Permissible output high current (maximum value per pin)	Ports P40 to P44, P46, ports PJ6, PJ7		–0.1	
	Ports other than above		–4.0	
Permissible output high current	Total of ports P40 to P44, P46, ports PJ6, PJ7	ΣI_{OH}	–0.6	
	Total of ports P03, P05, ports P26, P27, ports P30, P31		–10	
	Total of ports P14 to P17, port P32, ports P54, P55, ports PB0, PB1, PB3, PB5 to PB7, ports PC2 to PC7		–15	
	Total of ports PA0, PA1, PA3, PA4, PA6, ports PE0 to PE7		–15	
	Total of all output pins		–40	

Note: Do not exceed the permissible total supply current.

Table 5.19 Output Voltage (1)

Conditions: 2.7 V ≤ VCC = VCC_USB ≤ 3.6 V, 2.7 V ≤ AVSS0 ≤ 3.6 V, VSS = AVSS0 = VSS_USB = 0 V, T_a = –40 to +105°C

Item			Symbol	Min.	Max.	Unit	Test Conditions
Low-level output voltage	All output ports (except for RIIC, ports P40 to P44, P46, ports PJ6, PJ7)		V_{OL}	—	0.6	V	I_{OL} = 3.0 mA
				—	0.4		I_{OL} = 1.5 mA
	Ports P40 to P44, P46, ports PJ6, PJ7			—	0.4		I_{OL} = 0.4 mA
	RIIC pins	Standard mode		—	0.4		I_{OL} = 3.0 mA
		Fast mode		—	0.6		I_{OL} = 6.0 mA
High-level output voltage	All output ports (except for ports P40 to P44, P46, ports PJ6, PJ7)		V_{OH}	VCC – 0.5	—	V	I_{OH} = –2.0 mA
	Ports P40 to P44, P46, ports PJ6, PJ7			AVCC0 – 0.5	—		I_{OH} = –0.1 mA

Table 5.20 Output Voltage (2)

Conditions: 1.8 V ≤ VCC = VCC_USB ≤ 2.7 V, 1.8 V ≤ AVSS0 ≤ 2.7 V, VSS = AVSS0 = VSS_USB = 0 V, T_a = –40 to +105°C

Item		Symbol	Min.	Max.	Unit	Test Conditions
Low-level output voltage	All output ports (except for ports P40 to P44, P46, ports PJ6, PJ7)	V_{OL}	—	0.6	V	I_{OL} = 1.5 mA
	Ports P40 to P44, P46, ports PJ6, PJ7		—	0.4		I_{OL} = 0.4 mA
High-level output voltage	All output ports (except for ports P40 to P44, P46, ports PJ6, PJ7)	V_{OH}	VCC – 0.5	—	V	I_{OH} = –1.0 mA
	Ports P40 to P44, P46, ports PJ6, PJ7		AVCC0 – 0.5	—		I_{OH} = –0.1 mA

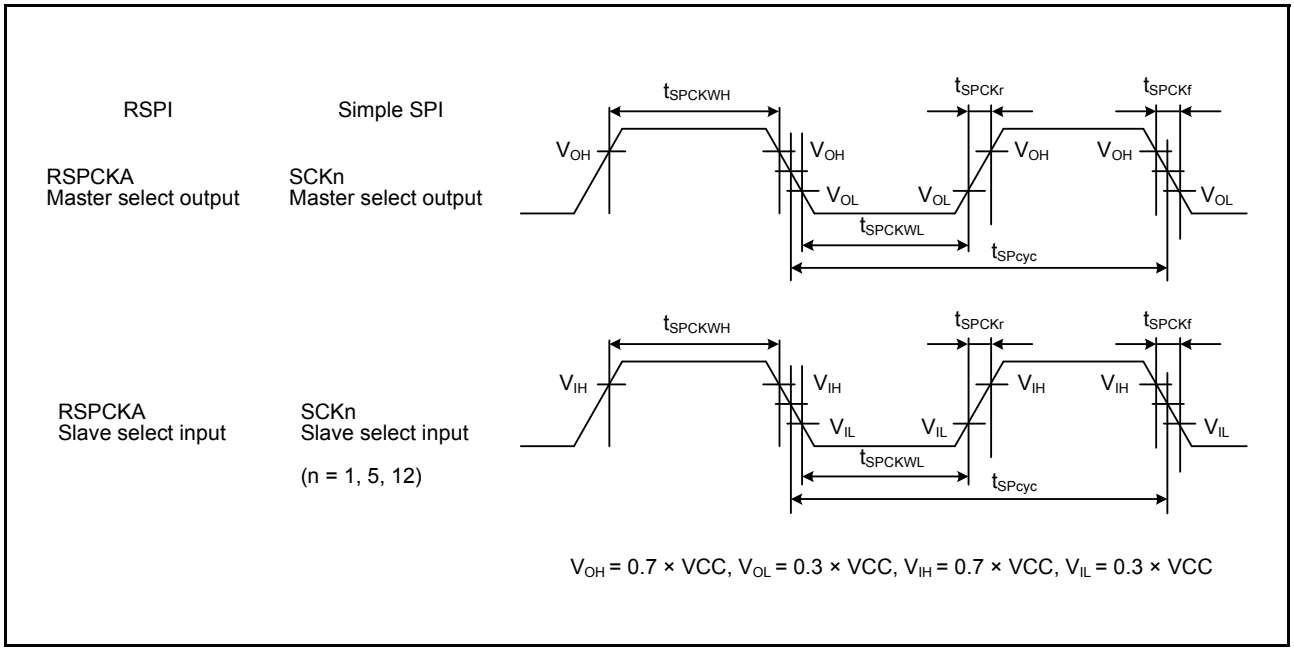


Figure 5.46 RSPI Clock Timing and Simple SPI Clock Timing

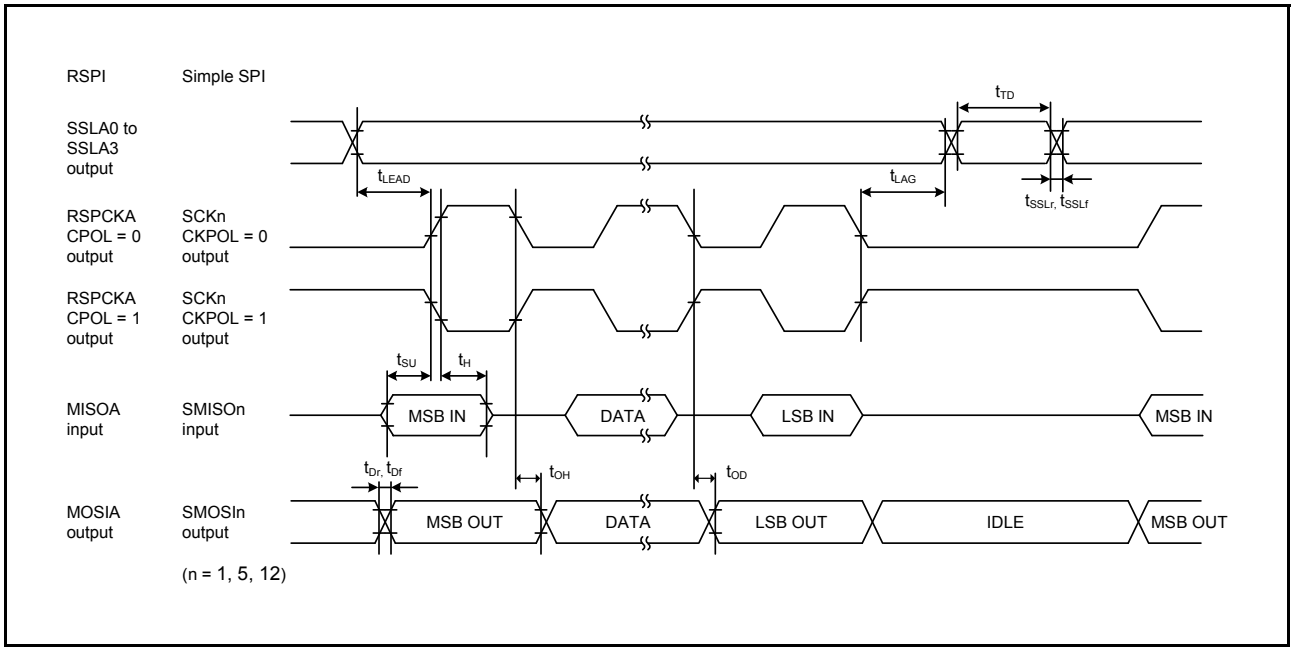


Figure 5.47 RSPI Timing (Master, CPHA = 0) (Bit Rate: PCLKB Set to Division Ratio Other Than Divided by 2) and Simple SPI Timing (Master, CKPH = 1)

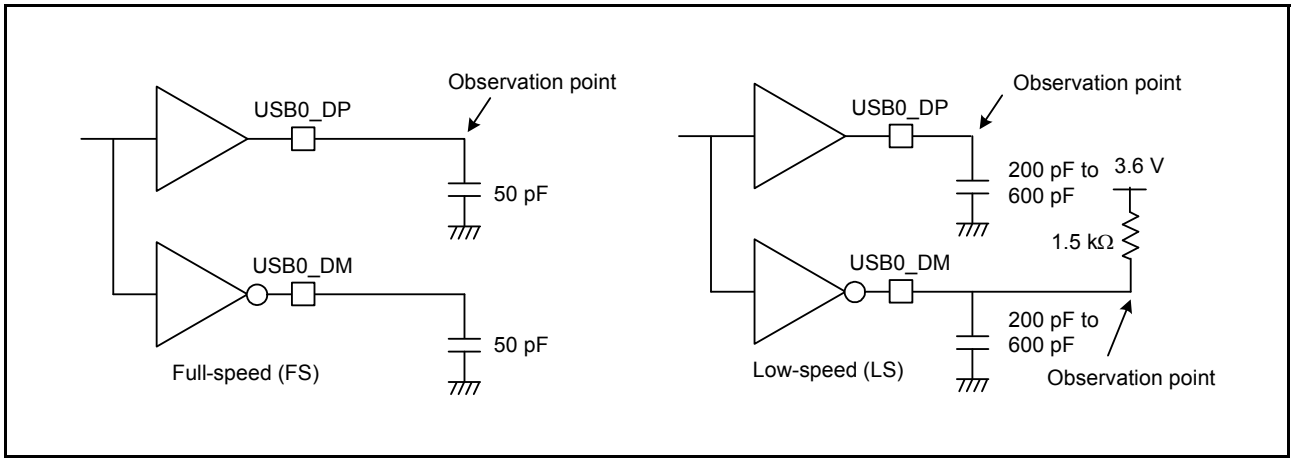


Figure 5.55 Test Circuit

5.11 E2 DataFlash Characteristics

Table 5.51 E2 DataFlash Characteristics (1)

Item		Symbol	Min.	Typ.	Max.	Unit	Conditions
Reprogramming/erasure cycle*1		N_{DPEC}	100000	1000000	—	Times	
Data hold time	After 10000 times of N_{DPEC}	t_{DDRP}	20*2, *3	—	—	Year	Ta = +85°C
	After 100000 times of N_{DPEC}		5*2, *3	—	—	Year	
	After 1000000 times of N_{DPEC}		—	1*2, *3	—	Year	Ta = +25°C

Note 1. The reprogram/erase cycle is the number of erasing for each block. When the reprogram/erase cycle is n times (n = 100000), erasing can be performed n times for each block. For instance, when 1-byte programming is performed 1000 times for different addresses in 1-byte block and then the entire block is erased, the reprogram/erase cycle is counted as one. However, programming the same address for several times as one erasing is not enabled (overwriting is prohibited).
Note 2. Characteristics when using the flash memory programmer and the self-programming library provided from Renesas Electronics.
Note 3. These results are obtained from reliability testing.

Table 5.52 E2 DataFlash Characteristics (2) : high-speed operating mode

Conditions: 2.7 V ≤ VCC ≤ 3.6 V, 2.7 V ≤ AVSS0 ≤ 3.6 V, VSS = AVSS0 = VSS_USB = 0 V

Temperature range for the programming/erasure operation: T_a = –40 to +105°C

Item		Symbol	FCLK = 1 MHz			FCLK = 32 MHz			Unit
			Min.	Typ.	Max.	Min.	Typ.	Max.	
Programming time	1-byte	t_{DP1}	—	86	761	—	40.5	374	µs
Erasure time	1-Kbyte	t_{DE1K}	—	17.4	456	—	6.15	228	ms
	8-Kbyte	t_{DE8K}	—	60.4	499	—	9.3	231	ms
Blank check time	1-byte	t_{DBC1}	—	—	48	—	—	15.9	µs
	1-Kbyte	t_{DBC1K}	—	—	1.58	—	—	0.127	µs
Erase operation forcible stop time		t_{DSED}	—	—	21.5	—	—	12.8	µs
DataFlash STOP recovery time		t_{DSTOP}	5	—	—	5	—	—	µs

Note: • Does not include the time until each operation of the flash memory is started after instructions are executed by software.
Note: • The lower-limit frequency of FCLK is 1 MHz during programming or erasing of the flash memory. When using FCLK at below 4 MHz, the frequency can be set to 1 MHz, 2 MHz, or 3 MHz. A non-integer frequency such as 1.5 MHz cannot be set.
Note: • The frequency accuracy of FCLK should be ±3.5%. Confirm the frequency accuracy of the clock source.

Table 5.53 E2 DataFlash Characteristics (3) : middle-speed operating mode

Conditions: 1.8 V ≤ VCC ≤ 3.6 V, 1.8 V ≤ AVSS0 ≤ 3.6 V, VSS = AVSS0 = VSS_USB = 0 V

Temperature range for the programming/erasure operation: T_a = –40 to +85°C

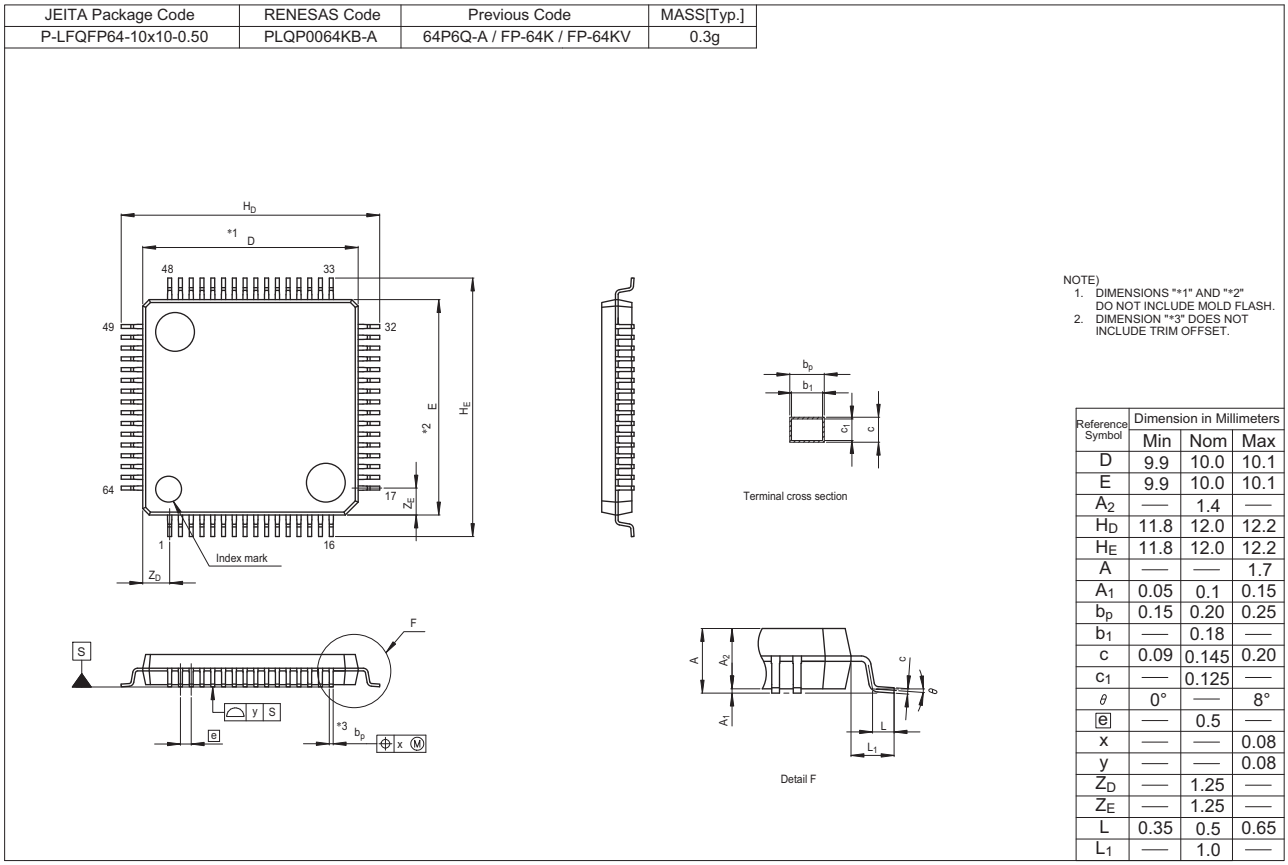
Item		Symbol	FCLK = 1 MHz			FCLK = 8 MHz			Unit
			Min.	Typ.	Max.	Min.	Typ.	Max.	
Programming time	1-byte	t_{DP1}	—	126	1160	—	85.4	818	µs
Erasure time	1-Kbyte	t_{DE1K}	—	17.5	457	—	7.76	259	ms
	8-Kbyte	t_{DE8K}	—	60.5	500	—	16.7	267.6	ms
Blank check time	1-byte	t_{DBC1}	—	—	78	—	—	50	µs
	1-Kbyte	t_{DBC1K}	—	—	1.61	—	—	0.369	ms
Erase operation forcible stop time		t_{DSED}	—	—	33.5	—	—	25.5	µs
DataFlash STOP recovery time		t_{DSTOP}	720	—	—	720	—	—	ns

Note: • Does not include the time until each operation of the flash memory is started after instructions are executed by software.
Note: • The lower-limit frequency of FCLK is 1 MHz during programming or erasing of the flash memory. When using FCLK at below 4 MHz, the frequency can be set to 1 MHz, 2 MHz, or 3 MHz. A non-integer frequency such as 1.5 MHz cannot be set.
Note: • The frequency accuracy of FCLK should be ±3.5%. Confirm the frequency accuracy of the clock source.

Appendix 1. Package Dimensions

Information on the latest version of the package dimensions or mountings has been displayed in “Packages” on Renesas Electronics Corporation website.

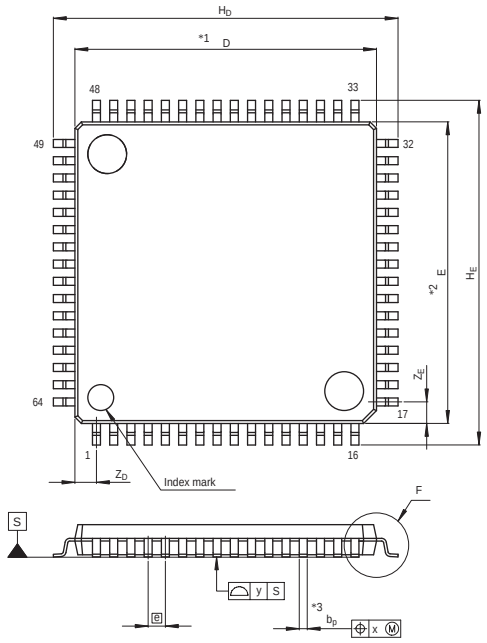
JEITA Package Code	RENESAS Code	Previous Code	MASS[Typ.]
P-LFQFP64-10x10-0.50	PLQP0064KB-A	64P6Q-A / FP-64K / FP-64KV	0.3g

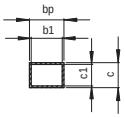


Reference Symbol	Dimension in Millimeters		
	Min	Nom	Max
D	9.9	10.0	10.1
E	9.9	10.0	10.1
A_2	—	1.4	—
H_D	11.8	12.0	12.2
H_E	11.8	12.0	12.2
A	—	—	1.7
A_1	0.05	0.1	0.15
b_p	0.15	0.20	0.25
b_1	—	0.18	—
c	0.09	0.145	0.20
c_1	—	0.125	—
θ	0°	—	8°
e	—	0.5	—
x	—	—	0.08
y	—	—	0.08
Z_D	—	1.25	—
Z_E	—	1.25	—
L	0.35	0.5	0.65
L_1	—	1.0	—

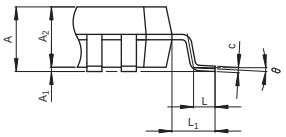
Figure A 64-Pin LFQFP (PLQP0064KB-A)

JEITA Package Code	RENESAS Code	Previous Code	MASS[Typ.]
P-LQFP64-14x14-0.80	PLQP0064GA-A	64P6U-A/ —	0.7g





Terminal cross section



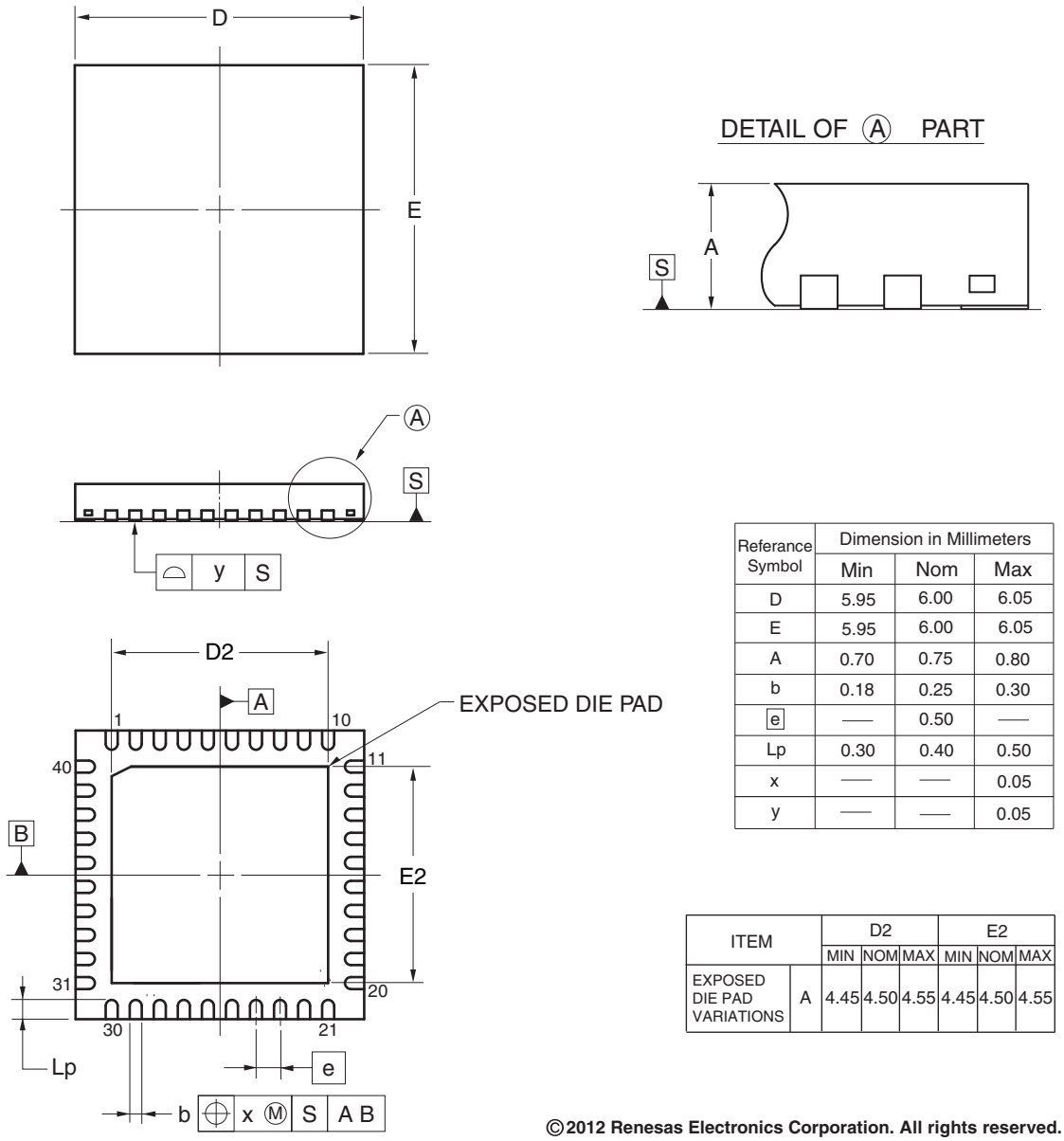
Detail F

NOTE)
1. DIMENSIONS "*1" AND "*2" DO NOT INCLUDE MOLD FLASH.
2. DIMENSION "*3" DOES NOT INCLUDE TRIM OFFSET.

Reference Symbol	Dimension in Millimeters		
	Min	Nom	Max
D	13.9	14.0	14.1
E	13.9	14.0	14.1
A_2	—	1.4	—
H_D	15.8	16.0	16.2
H_E	15.8	16.0	16.2
A	—	—	1.7
A_1	0	0.1	0.2
b_p	0.32	0.37	0.42
b_1	—	0.35	—
c	0.09	0.145	0.20
c_1	—	0.125	—
θ	0°	—	8°
e	—	0.8	—
x	—	—	0.20
y	—	—	0.10
Z_D	—	1.0	—
Z_E	—	1.0	—
L	0.3	0.5	0.7
L_1	—	1.0	—

Figure B 64-Pin LQFP (PLQP0064GA-A)

JEITA Package Code	RENESAS Code	Previous Code	MASS (TYP.) [g]
P-HWQFN40-6x6-0.50	PWQN0040KC-A	P40K8-50-4B4-4	0.09



Referance Symbol	Dimension in Millimeters		
	Min	Nom	Max
D	5.95	6.00	6.05
E	5.95	6.00	6.05
A	0.70	0.75	0.80
b	0.18	0.25	0.30
e	—	0.50	—
Lp	0.30	0.40	0.50
x	—	—	0.05
y	—	—	0.05

ITEM		D2			E2		
		MIN	NOM	MAX	MIN	NOM	MAX
EXPOSED DIE PAD VARIATIONS	A	4.45	4.50	4.55	4.45	4.50	4.55

Figure F 40-Pin HWQFN (PWQN0040KC-A)

Rev.	Date	Description	
		Page	Summary
1.20	Sep 29, 2014	85	Figure 5.41 RSPI Clock Timing and Simple SPI Clock Timing, Figure 5.42 RSPI Timing (Master, CPHA = 0) (Bit Rate: PCLKB Set to Division Ratio Other Than Divided by 2) and Simple SPI Timing (Master, CKPH = 1) changed
		86	Figure 5.43 RSPI Timing (Master, CPHA = 0) (Bit Rate: PCLKB Set to Divided by 2) added, Figure 5.44 RSPI Timing (Master, CPHA = 1) (Bit Rate: PCLKB Set to Division Ratio Other Than Divided by 2) and Simple SPI Timing (Master, CKPH = 0) changed
		87	Figure 5.45 RSPI Timing (Master, CPHA = 1) (Bit Rate: PCLKB Set to Divided by 2) added, Figure 5.46 RSPI Timing (Slave, CPHA = 0) and Simple SPI Timing (Slave, CKPH = 1) changed
		88	Figure 5.47 RSPI Timing (Slave, CPHA = 1) and Simple SPI Timing (Slave, CKPH = 0) changed
		89	Table 5.37 USB Characteristics (USB0_DP and USB0_DM Pin Characteristics) and Figure 5.49 USB0_DP and USB0_DM Output Timing, changed
		90	Figure 5.50 Test Circuit, changed
		91	Table 5.38 A/D Conversion Characteristics (1), Figure 5.51 AVCC0 to AVREFH0 Voltage Range, changed
		92	Table 5.39 A/D Conversion Characteristics (2), Table 5.40 A/D Conversion Characteristics (3) changed
		101	Table 5.49 ROM (Flash Memory for Code Storage) Characteristics (2) and Table 5.50 ROM (Flash Memory for Code Storage) Characteristics (3), changed
		102	Table 5.52 E2 DataFlash Characteristics (2), Table 5.53 E2 DataFlash Characteristics (3) changed
1.21	Dec 09, 2014	1. Overview	
		2 to 4	Table 1.1 Outline of Specifications Unique ID, changed
		5. Electrical Characteristics	
		51	Table 5.3 DC Characteristics (1) and Table 5.4 DC Characteristics (2), changed
		61	Table 5.19 Output Voltage (1) and Table 5.20 Output Voltage (2), changed
		102	Table 5.52 E2 DataFlash Characteristics (2): high-speed operating mode and Table 5.53 E2 DataFlash Characteristics (3): middle-speed operating mode, changed